# MGV252012R47M-10

### PHYSICAL DIMENSIONS:

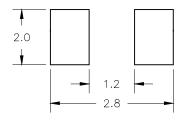
A  $2.50 \pm 0.20$ 

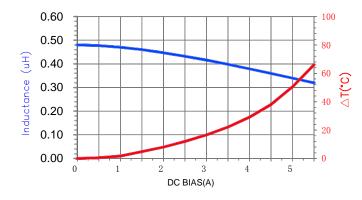
B  $2.00 \pm 0.20$ 

C 1.20 Max.

 $D = 0.60 \pm 0.30$ 

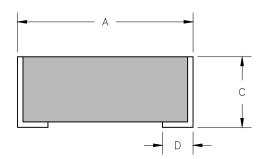
#### LAND PATTERNS FOR REFLOW SOLDERING



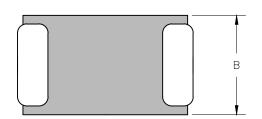


## ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max
INDUCTANCE (uH) L @ 1MHz/1mA ±20%	0.376	0.47	0.564
DCR $(\Omega)$		0.021	0.025
Saturation Current Isat (A)		5.30	4.95
Heating Current Irms (A)		4.60	4.18







#### NOTES:

- 1. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. OPERATING TEMPERATURE RANGE:  $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ .
- 4. STORAGE TEMPERATURE RANGE: -50°C ~ +125°C .
- 5. ISat MEANS THAT MAX DC CURRENT WILL CAUSE A PROXIMATELY 30% INDUCTANCE REDUCTION FROM INITIAL VALUE.
- 6. Irms MEANS THAT MAX DC CURRENT WILL CAUSE PROXIMATELY 40°C TEMPERATURE RISE FROM 25±5°C AMBIENT.

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